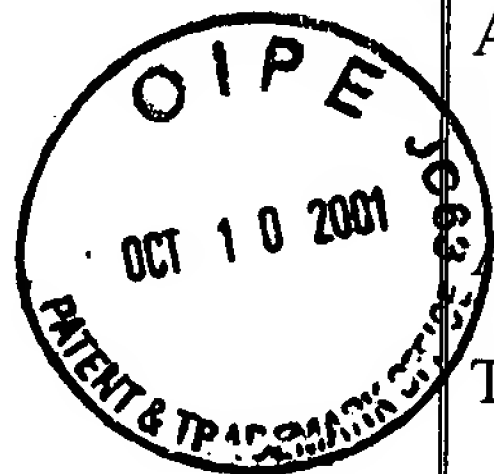


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicants: Won Sun Shin, Do Sung Chun, Sang Ho Lee, Seon Goo Lee, Vincent DiCaprio

Assignee: Amkor Technology, Inc.

Title: Semiconductor Package And Method For Fabricating The Same

Serial No.: 09/574,541

Filing Date: May 19, 2000

Batch No.: M03

Date Allowed: September 17, 2001

Examiner: C. Luu

Group Art Unit: 2825

Docket No.: AB-975 US

San Jose, California  
October 10, 2001

BOX ISSUE FEE  
COMMISSIONER FOR PATENTS  
Washington, D. C. 20231

**REQUEST FOR CONSIDERATION OF PREVIOUSLY SUBMITTED  
INFORMATION DISCLOSURE STATEMENT**

Dear Sir:

The Applicants thank the Examiner for the Notice of Allowance dated September 17, 2001. An Information Disclosure Statement (IDS) and PTO Form 1449 citing various patent applications and references were submitted to the Office on July 18, 2001. These documents were received by the Office approximately two months before the Notice of Allowance was mailed, as indicated by a Return Receipt Postcard stamped and returned by the Office. A copy of the IDS, Form 1449, and Return Receipt Postcard indicating receipt by the Office are attached hereto. Applicants request that the Examiner consider the Information Disclosure

LAW OFFICES OF  
SKJERVEN MORRILL  
MACPHERSON LLP

25 METRO DRIVE  
SUITE 700  
SAN JOSE, CA 95110  
(408) 453-9200  
FAX (408) 453-7979

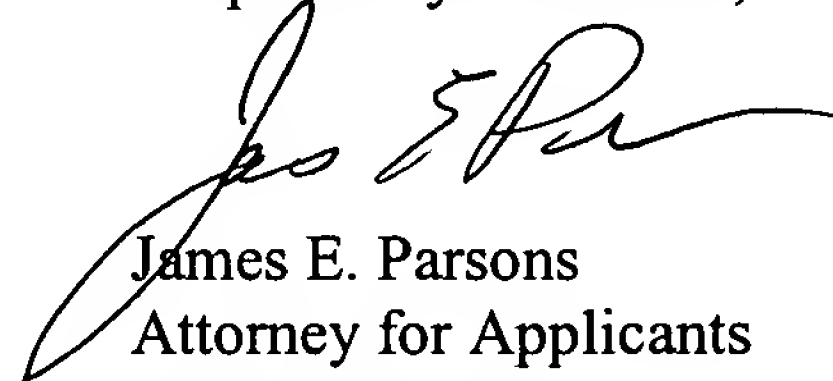
**Match & Return**

Statement and cited documents and return an initialed copy of the PTO Form 1449. Please direct any questions or comments to the undersigned at (408) 487-1315.

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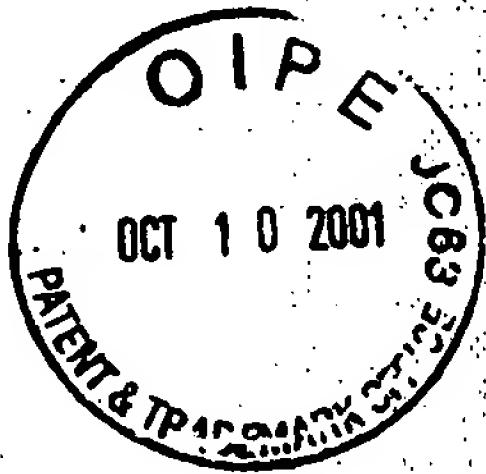
Respectfully submitted,



James E. Parsons  
Attorney for Applicants  
Reg. No. 34,691

LAW OFFICES OF  
SKJERVEN MORRILL  
MACPHERSON LLP

25 METRO DRIVE  
SUITE 700  
SAN JOSE, CA 95110  
(408) 453-9200  
FAX (408) 453-7979



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WASHINGTON, D.C. 20231

Applicants: Shin, Won Sun; Chun, DoSung; Lee, SangHo; Lee, SeonGoo; DiCaprio, Vincent  
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Serial No.: 09/574,541  
Filed: May 19, 2000  
Atty Docket No.: AB-975 US

ENCLOSED:

1. This Return Receipt Postcard;
2. Information Disclosure Statement Under 37 CFR Section 1.97(b) (2 pp.);
3. PTO Form 1449 (7 pages);
4. Copies of 101 Cited References.

JEP/cb

July 18, 2001

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gm

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WASHINGTON, D.C. 20231

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